LN11WP38

Round Type

 $\phi 5.0 \ mm$

■ Absolute Maximum Ratings $T_a = 25$ °C

• Yellow Green

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	90	mW	
Forward current	I_{F}	30	mA	
Pulse forward current *	I_{FP}	150	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

• Orange

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	90	mW	
Forward current	I_{F}	30	mA	
Pulse forward current *	I_{FP}	150	mA	
Reverse voltage	V _R	3	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Electro-Optical Characteristics $T_a = 25$ °C

• Yellow Green

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O		3.0	15.0		mcd
Reverse current	I_R	$V_R = 4 V$			10	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$		2.2	2.8	V
Peak emission wavelength	λ_{P}	$I_F = 20 \text{ mA}$		565		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$		30		nm

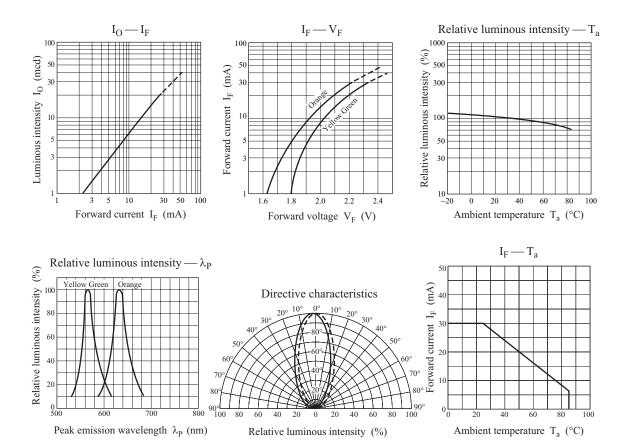
• Orange

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I _O		3.0	15.0		mcd
Reverse current	I_R	$V_R = 3 V$			10	μΑ
Forward voltage	V_{F}	$I_F = 20 \text{ mA}$		2.1	2.8	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$		630		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$		40		nm

■ Lighting Color

- Yellow Green
- Orange

LN11WP38 Panasonic

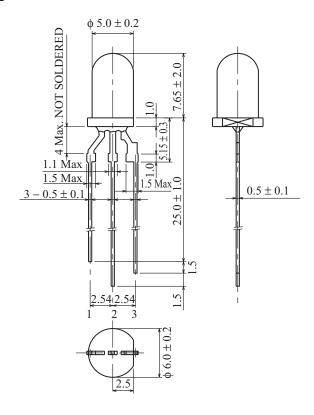


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Panasonic LN11WP38

■ Package (Unit: mm)

LLXLTN3SH012



- Pin name
 - 1: Anode (Orange)
 - 2: Cathode (Common)
 - 3: Anode (Yellow Green)

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